

# **Hearing Aids Mems Mic**

### **DESCRIPTION**

The WBC6556 is a high quality, high performance, low power analog output bottom-ported omni-directional MEMS microphone.WBC6556consists of a MEMS microphone element and an preamplifier. WBC6556has a high SNR and flat wideband frequency response, resulting in natural sound with high intelligibility. Extra EMI filter for RF noise attenuation is built inside. Due to the built-in filter, WBC6556shows high immunity to E MI. The WBC6556is available in a thin 2.75mm × 1.85mm × 0.90mm surface-mount package. It is reflow solder compatible with no sensitivity degradation. The WBC6556 is halide Halogen and Lead free.

### **APPLICATIONS**

Hearing Aids

### ORDERING INFORMATION

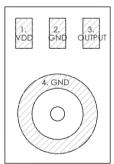
| PART    | RoHS | Ship, Quantity      |
|---------|------|---------------------|
| WBC6556 | Yes  | Tape and Reel, 5.2K |

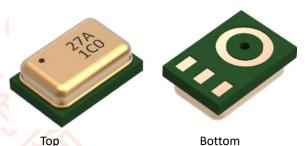
#### **FEATURES**

- Small package
- Flat Frequency Response SNR of 64dBA
- Low Current
- Max RF protection
- Ultra-Stable Performance
- Standard SMD Reflow
- Omni-directional

### **Pins Configuration and Description**

#### **Bottom view**

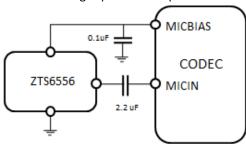




Isometric Views of WBC6556Microphone Package
All Pictures shown are for illustration purpose only

### **Typical Applications**

The WBC6556output can be connected to a codec microphone input or to a high input impedance gain stag e.A dc-blocking capacitor is required at the output of the microphone.



Connect to Audio OPAM

Note: All Ground pins must be connected to ground.

Capacitors near the microphone should not contain Class 2 dielectrics.

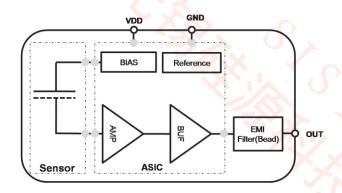


## **Absolute Maximum Ratings**

| V <sub>DD</sub> to Ground   | 0.5V to +5.0V                 |
|-----------------------------|-------------------------------|
| Out to Ground               | 0.3V to V <sub>DD</sub> +0.3V |
| Input Current               | ±5mA                          |
| Operating Temperature Range | 40°C to +125°C                |
| Storage Temperature Range   | 40°C to +125°C                |

**CAUTION**: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

## **Functional Block Diagram**



## **Electro-Static Discharge Sensitivity**

This integrated circuit can be damaged by ESD. It is recommended that all integrated circuits be handled with proper precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure.

## **Pins Description**

| Pin | Symbol | Description           |
|-----|--------|-----------------------|
| 1   | VDD    | Power Supply          |
| 2   | GROUND | Ground                |
| 3   | OUT    | Analog output signal. |
| 4   | GROUND | Ground                |



## **Specifications**

(TA = +23°C, VDD = +1.8V, R.H. = 60%~70%, no load, VDD Decoupling cap=0.1uF unless otherwise noted.)

| PARAMETER                         | Symbol           | CONDITIONS  | MIN  | ТҮР        | MAX         | UNIT   |
|-----------------------------------|------------------|---|------|------------|-------------|--------|
| Supply Voltage <sup>1</sup>       | $V_{DD}$         |   | 0.9  | -          | 3. 6        | V      |
| Supply Current <sup>1,2</sup>     | I <sub>DD</sub>  |   | -    | 26         | -           | μΑ     |
| Sensitivity <sup>1</sup>          | S                | 94 dB SPL @ 1 kHz                                 | -38  | -35        | -32         | dBV/Pa |
| Equivalent noise                  | Noise            | 10HZ - 8kHZ                                       |      | 27.5       | 28.5        | dBSPL  |
| (A-weighted)                      | Noise            | 10HZ - 20kHZ                                      |      | 30         | 31          | dBSPL  |
| Signal to Noise Ratio             | SNR              | 94 dB SPL @ 1 kHz                                 | -    | 64         | -           | dB(A)  |
| 1/3 Octave equivalent input noise |                  | @1kHZ   |      | 15.5       | 16.5        | dBSPL  |
| Total Harmonic Distortion         | THD              | 94 dB SPL @ 1 kHz                                 | -    | 0.1        | 1           | %      |
| Acoustic Over load Point          | AOP              | 10% THD @ 1 kHz                                   |      | 120        | -           | dB SPL |
| Power Supply Rejection Ratio      | PSRR             | 1 kHz, 200mVpp sine wave on V <sub>DD</sub>       | -    | 65         | -           | dB     |
| Power Supply Rejection            | PSR              | 217 Hz, 100mVpp<br>square wave on V <sub>DD</sub> | -    | -90        | -           | dBV(A) |
| DC Output voltage                 | Vout_dc          |   | 0.45 |            | 0.65        | V      |
| Output Impedance                  | Z <sub>OUT</sub> | @ 1 kHz   | -    | 4000       | -           | Ω      |
| Directivity                       |                  |   |      | Omni-di    | rectional   |        |
| Polarity                          |                  | Increasing sound pressure                         | Inci | reasing ou | itput press | ure    |

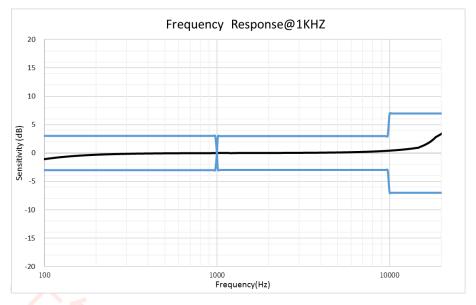
#### Note:

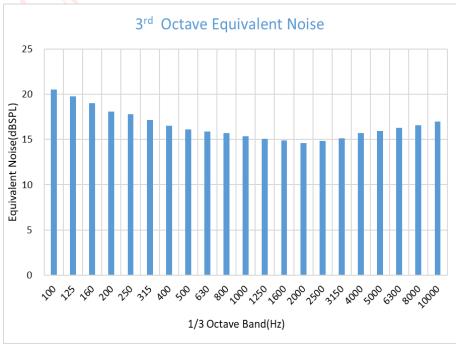
<sup>&</sup>lt;sup>1</sup> 100% tested

<sup>&</sup>lt;sup>2</sup> Maximum specifications are measured at maximum  $V_{DD}$ . Typical specifications are measured at  $V_{DD} = 0.9V$ .



## **Typical Performance Characteristics**







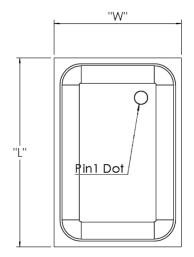
# **Reliability Specifications**

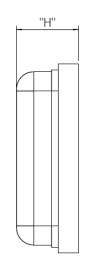
The microphone sensitivity after stress must deviate by no more than ±3dB from the initial value.

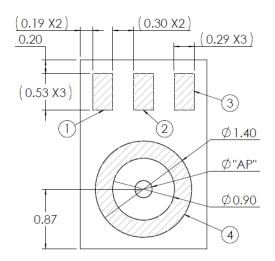
| 4 Hast Tast On and in 1                 | T 435 : 3.00  |
|---|---|
| Heat Test, Operational                  | Temperature: 125±3 °C                                 |
|   | Duration: 1000 hours                                  |
|   | Voltage: Applied                                      |
| 2. Cold Test, Operational               | Temperature: -40±3°C                                  |
|   | Duration: 1000 hours                                  |
|   | Voltage: Applied                                      |
| 3. Heat Test, Non-Operational           | Temperature: 125±3°C                                  |
|   | Duration: 1000 hours                                  |
|   | Voltage: Not Applied                                  |
| 4. Cold Test, Non-Operational           | Temperature: -40±3°C                                  |
| , .                                     | Duration:1000 hours                                   |
|   | Voltage: Not Applied                                  |
| 5. Thermal Shock Test, Non-Operational  | Temperature: -40±3°C and 125±3°C                      |
| 5. Thermal shock rest, from operational | Duration: 30 minutes each, during 5                   |
|   | minutes ramp, 256 cycles                              |
|   | Voltage: Not applied                                  |
| 6. Temperature humidity storage         | Temperature: 85±3°C                                   |
| or remperature namency storage          | Humidity: 85±3%RH                                     |
| <3D. (P)                                | Duration: 1000 hours                                  |
|   | Temperature: 65±3°C                                   |
|   | Humidity: 95±3%RH                                     |
|   | Duration: 168 hours                                   |
| 7. Free Fall Test 1.5m                  |   |
| 7. Free Fall Test 1.5m                  | Placed inside test fixture and dropped on             |
|   | concrete from height 1.5m.                            |
| 0. 1/1. 1:                              | 4 times by each surface and corner                    |
| 8. Vibration                            | 4 cycles of 20 to 2000 Hz sinusoidal sweep            |
|   | with 20G peak acceleration lasting 12                 |
|   | minutes in X, Y, and Z directions                     |
| 9. Mechanical Shock                     | 5 pulses of 10000g in each of the $\pm X$ , $\pm Y$ , |
|   | and ±Z directions                                     |
| 10. Electrostatic Discharge Test        | Capacitance: 150pF                                    |
|   | Resistance: 330Ω                                      |
|   | Duration: 10 times                                    |
|   | Air Discharge: Level 4(+/-15kV)                       |
|   | Direct contact discharge: Level 4 (+/-8kV)            |
| 11. Human Body Mode                     | ±5000 Volt  |
| 12. Charged-Device Model                | ±500 Volt   |
| 13. Reflow                              | 5 reflow cycles with peak temperature of              |
|   | 260°C   |
| 14. Solderability                       | 245 ± 5 °C ,5sec, 95% Tin on pad surface              |
| 15. Tumble test                         | 300 tumbles from a height of 1m onto a steel          |
|   | base.   |
| 16. HAST                                | Temperature: 130±3°C                                  |
|   | Humidity: 85±3%RH                                     |
|   | Duration: 96 hours                                    |
|   | Voltage: Applied                                      |
| 17. Air Blow                            | ,   |
| 17. All DIUW                            | 0.45MPa, distance 3cm, time 10s                       |



### **MECHANICAL SPECIFICATIOPNS**







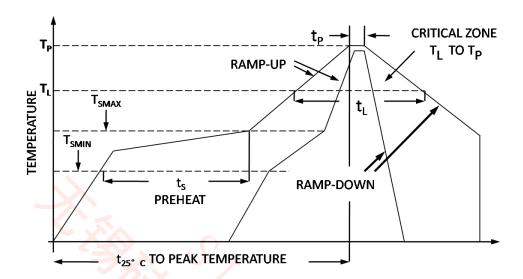
| Item               | Dimension | Tolerance |
|--------------------|-----------|-----------|
| Length (L)         | 2.75      | ±0.10     |
| Width (W)          | 1.85      | ±0.10     |
| Height (H)         | 0.90      | ±0.10     |
| Acoustic Port (AP) | Ø0.25     | ±0.050    |

| Pin# | Pin Name | Туре   | Description           |
|------|----------|--------|-----------------------|
| 1    | VDD      | Power  | Power Supply          |
| 2    | GROUND   | Ground | Ground                |
| 3    | OUT      | Output | Analog output signal. |
| 4    | GROUND   | Ground | Ground                |
|      |          |        |                       |



### **SOLDER FLOW PROFILE**

The reflow profile specified in this section describes expected maximum heat exposure of components during the reflow process of NMP product PWBs. Temperature is measured on top of component. All components have to tolerate at least this profile five times (5x) without affecting electrical performance, mechanical performance or reliability.



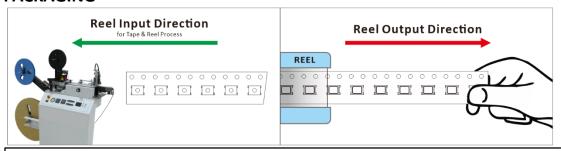
Pb-free and Sn63/Pb37 reflow profile requirements for soldering heat resistance:

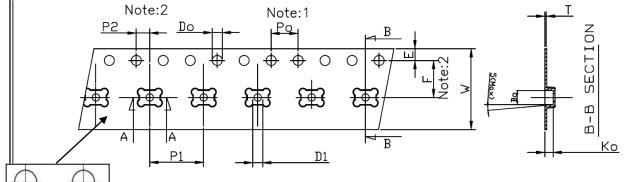
| Parameter   |                     | Reference                              | Pb-Free          |
|---|---------------------|--|------------------|
| Average Ramp Rate                                   |                     | T <sub>L</sub> to T <sub>P</sub>       | 3°C/sec max      |
|   | Minimum Temperature | T <sub>SMIN</sub>                      | 150°C            |
| Preheat   | Maximum Temperature | T <sub>SMAX</sub>                      | 200°C            |
|   | Time                | T <sub>SMIN</sub> to T <sub>SMAX</sub> | 60sec to 180sec  |
| Time Maintained Above                               | Temperature         | T∟                                     | 217°C            |
| Time Maintained Above                               | Time                | tL                                     | 60sec to 150sec  |
| Peak Temperature                                    |                     | Тр                                     | 260°C            |
| Time Within +5°C of Actual Peak Temperature         |                     | t <sub>P</sub>                         | 20 sec to 40 sec |
| Ramp-Down Rate                                      |                     | $T_{peak}$                             | 6°C/sec max      |
| Time +25°C (t <sub>250C</sub> ) to Peak Temperature |                     |  | 8 min max        |

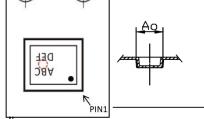
ADDIOTIONAL NOTES: MSL (moisture sensitivity level) Class 1.



### **PACKAGING**







$$A_0 = 3.05 \pm 0.10$$
 mm

$$Bo = 2.10 \pm 0.10$$
 mm

$$K_0 = 1.50 \pm 0.10$$
 mm

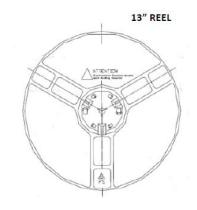
#### Unit: mm

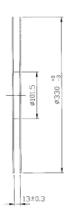
| Offic. Ithiri |                   |
|---------------|-------------------|
| Symbol        | Spec.             |
| Ро            | 4.0±0.10          |
| P1            | 8.0±0.10          |
| P2            | 2.0±0.05          |
| Do            | 1.50 +0.10<br>-0. |
| D1            | 1.10±0.10         |
| Е             | 1.75±0.10         |
| F             | 5.50±0.05         |
| 10Po          | 40.0±0.10         |
| W             | 12.0±0.10         |
| Т             | 0.30±0.05         |
|               |                   |

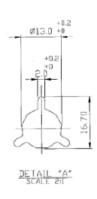
### Notice:

- 10 Sprocket hole pitch cumulative tolerance is ±0.1mm
- 2. Pocket position relative to sprocket hole measured as true position of pocket not pocket hole.
- 3. Ao & Bo measured on a place 0.3mm above the bottom of the pocket to top surface of the carrier.
- 4. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- 5. Carrier camber shall be not than 1mm per 100mm through a length of 250mm.



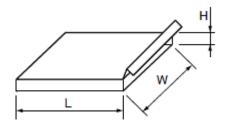






| Part NO. | Reel Diameter | Quantity Per Reel | Quantity Per<br>Inner Box | Quantity Per<br>Outer Box |
|----------|---------------|-------------------|---------------------------|---------------------------|
| WBC6556  | 13"           | 5200              | 5200                      | 46800                     |

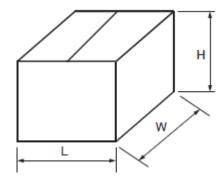
## **Dimensions for Inner Box**



Unit: mm

| L   | W   | Н  |
|-----|-----|----|
| 335 | 339 | 45 |

## **Dimensions for Outer Box**



Unit: mm

| L   | W   | Н   |
|-----|-----|-----|
| 445 | 360 | 372 |